

To all our customers

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Renesas Technology Corp.  
Customer Support Dept.  
April 1, 2003

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# HD74BC540A

## Octal Buffers/Line Drivers With 3 State Outputs



ADE-205-031 (Z)  
1st. Edition  
Jan. 1993

### Description

The HD74BC540A provides high drivability and operation equal to or better than high speed bipolar standard logic IC by using Bi-CMOS process. The device features low power dissipation that is about 1/5 of high speed bipolar logic IC, when the frequency is 10 MHz. The device has eight inverter drivers with three state outputs in a 20 pin package. When  $\overline{G1}$  and  $\overline{G2}$  is low level, this drivers set up output is enable.

### Features

- Input/Output are at high impedance state when power supply is off.
- Built in input pull up circuit can make input pins be open, when not used.
- Input is TTL level.
- Wide operating temperature range  
 $T_a = -40$  to  $+85^{\circ}\text{C}$

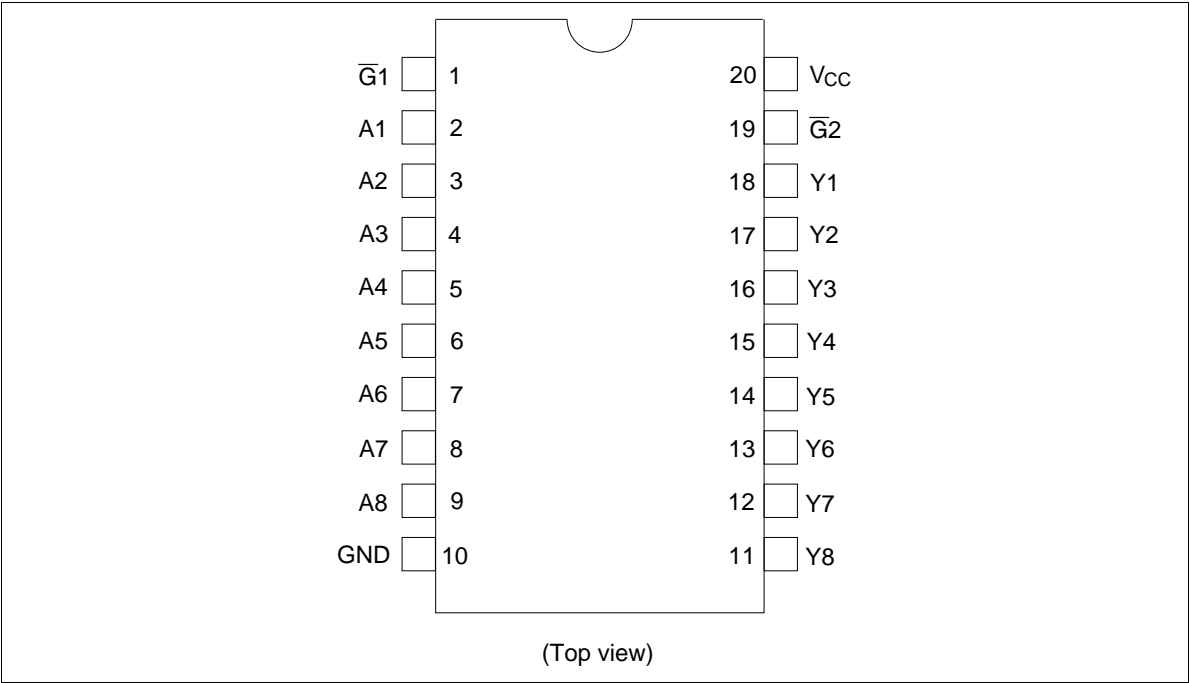
### Function Table

#### Inputs

$\overline{G1}$	$\overline{G2}$	A	Output Y
L	L	L	H
L	L	H	L
H	X	X	Z
X	H	X	Z

H : High level  
L : Low level  
X : Immaterial  
Z : High impedance

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	-0.5 to +7.0	V
Input diode current	$I_{IK}$	$\pm 30$	mA
Input voltage	$V_{IN}$	-0.5 to +7.5	V
Output voltage	$V_{OUT}$	-0.5 to +7.5	V
Off state output voltage	$V_{OUT(off)}$	-0.5 to +5.5	V
Storage temperature	Tstg	-65 to +150	°C

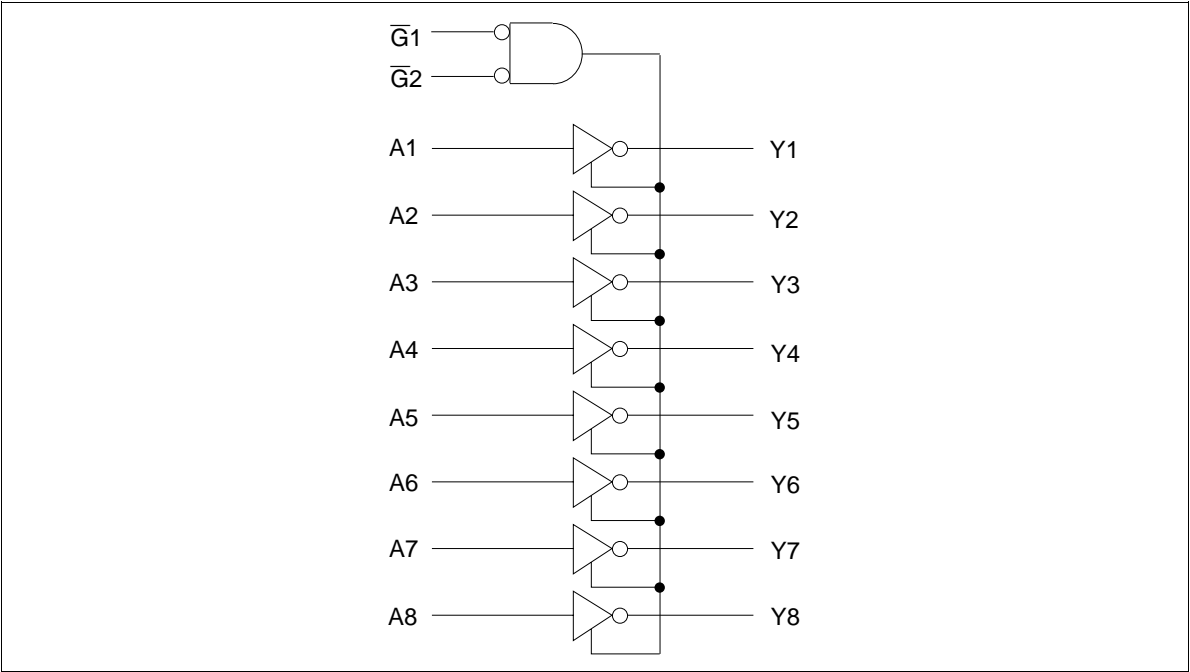
Note: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.5	5.0	5.5	V
Input voltage	$V_{IN}$	0	—	$V_{CC}$	V
Ouput voltage	$V_{OUT}$	0	—	$V_{CC}$	V
Operating temperature	$T_{opr}$	−40	—	85	°C
Input rise/fall time*1	$t_r, t_f$	0	—	8	ns/V

Note: 1. This item guarantees maximum limit when one input switches.  
Waveform: Refer to test circuit of switching characteristics.

Logic Diagram



## Electrical Characteristics (Ta = -40 to +85°C)

Item	Symbol	V <sub>CC</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>		2.0	—	V	
	V <sub>IL</sub>		—	0.8	V	
Output voltage	V <sub>OH</sub>	4.5	2.4	—	V	I <sub>OH</sub> = -3 mA
		4.5	2.0	—	V	I <sub>OH</sub> = -15 mA
	V <sub>OL</sub>	4.5	—	0.5	V	I <sub>OL</sub> = 48 mA
		4.5	—	0.55	V	I <sub>OL</sub> = 64 mA
Input diode voltage	V <sub>IK</sub>	4.5	—	-1.2	V	I <sub>IN</sub> = -18 mA
Input current	I <sub>I</sub>	5.5	—	-250	μA	V <sub>IN</sub> = 0 V
		5.5	—	1.0	μA	V <sub>IN</sub> = 5.5 V
		5.5	—	100	μA	V <sub>IN</sub> = 7.0 V
Short circuit output current*1	I <sub>OS</sub>	5.5	-100	-225	mA	V <sub>IN</sub> = 0 or 5.5 V
Off state output current	I <sub>OZH</sub>	5.5	—	50	μA	V <sub>O</sub> = 2.7 V
	I <sub>OZL</sub>	5.5	—	-50	μA	V <sub>O</sub> = 0.5 V
Supply current	I <sub>CCL</sub>	5.5	—	27.5	mA	V <sub>IN</sub> = 0 or 5.5 V All outputs is "L"
	I <sub>CCH</sub>	5.5	—	2.5	mA	V <sub>IN</sub> = 0 or 5.5 V All outputs is "H"
	I <sub>CCZ</sub>	5.5	—	2.5	mA	V <sub>IN</sub> = 0 or 5.5 V All outputs is "Z"
	I <sub>CCT</sub> *2	5.5	—	1.5	mA	V <sub>IN</sub> = 3.4V or 0.5V

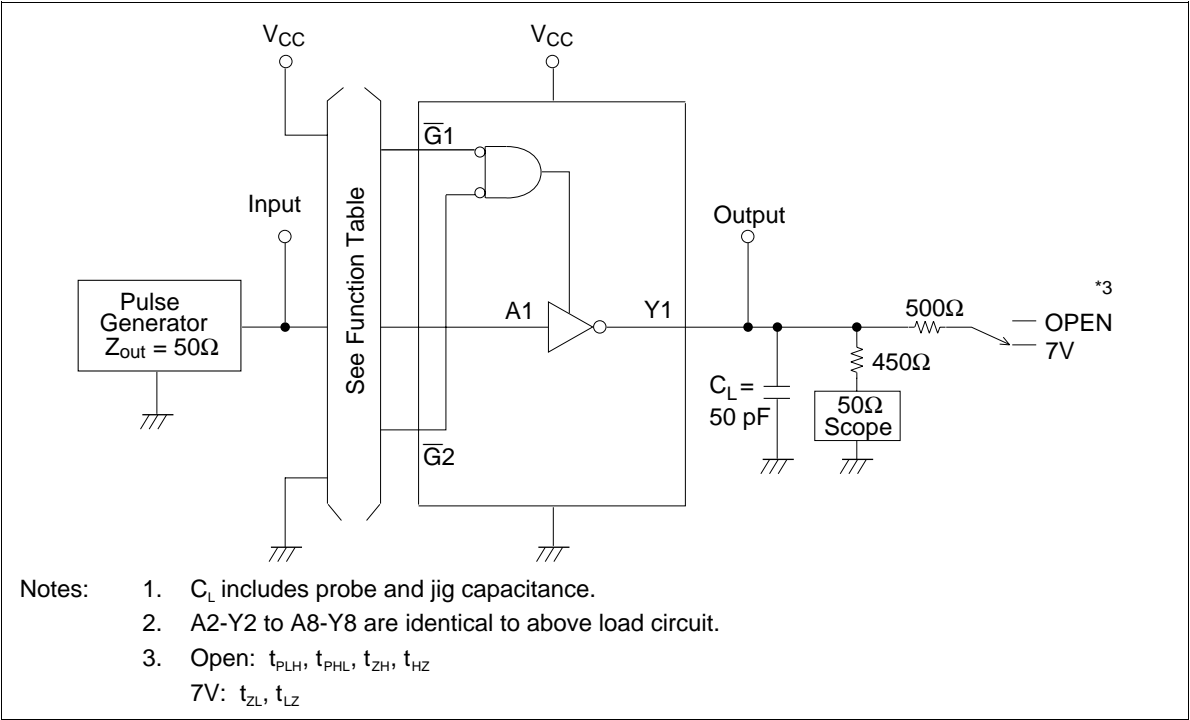
Notes: 1. Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

2. When input by the TTL level, it shows I<sub>CC</sub> increase at per one input pin.

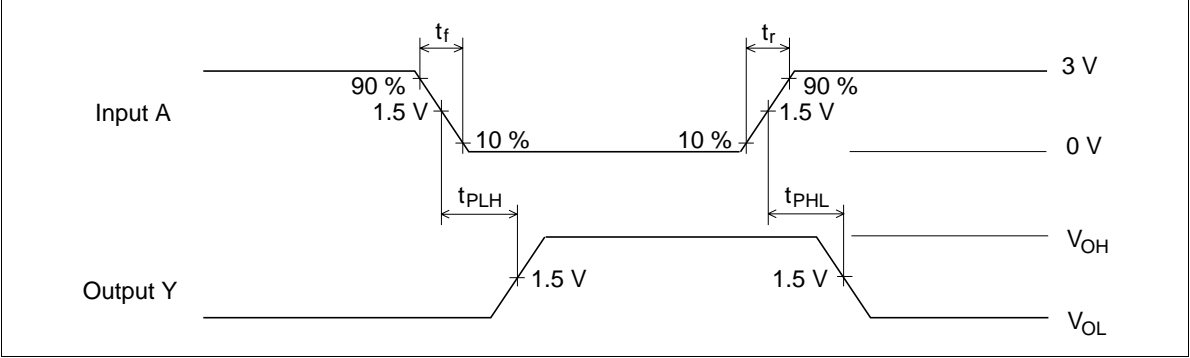
Switching Characteristics (C<sub>L</sub> = 50 pF)

Item	Symbol	Ta = 25°C V <sub>CC</sub> = 5.0 V		Ta = -40 to +85°C V <sub>CC</sub> = 5.0 V ±10		Unit	Test Conditions
		Min	Max	Min	Max		
Propagation delay time	t <sub>PLH</sub>	3.0	6.0	3.0	7.0	ns	See under figure
	t <sub>PHL</sub>	3.0	6.0	3.0	7.0		
Output enable time	t <sub>ZH</sub>	3.0	9.0	3.0	11.0	ns	
	t <sub>ZL</sub>	3.0	9.0	3.0	11.0		
Output disable time	t <sub>HZ</sub>	3.0	8.0	3.0	10.0	ns	
	t <sub>LZ</sub>	3.0	8.0	3.0	10.0		
Input capacitance	C <sub>IN</sub>	3.0(Typ)		—		pF	V <sub>IN</sub> = V <sub>CC</sub> or GND
Output capacitance	C <sub>O</sub>	15.0(Typ)		—		pF	V <sub>O</sub> = V <sub>CC</sub> or GND

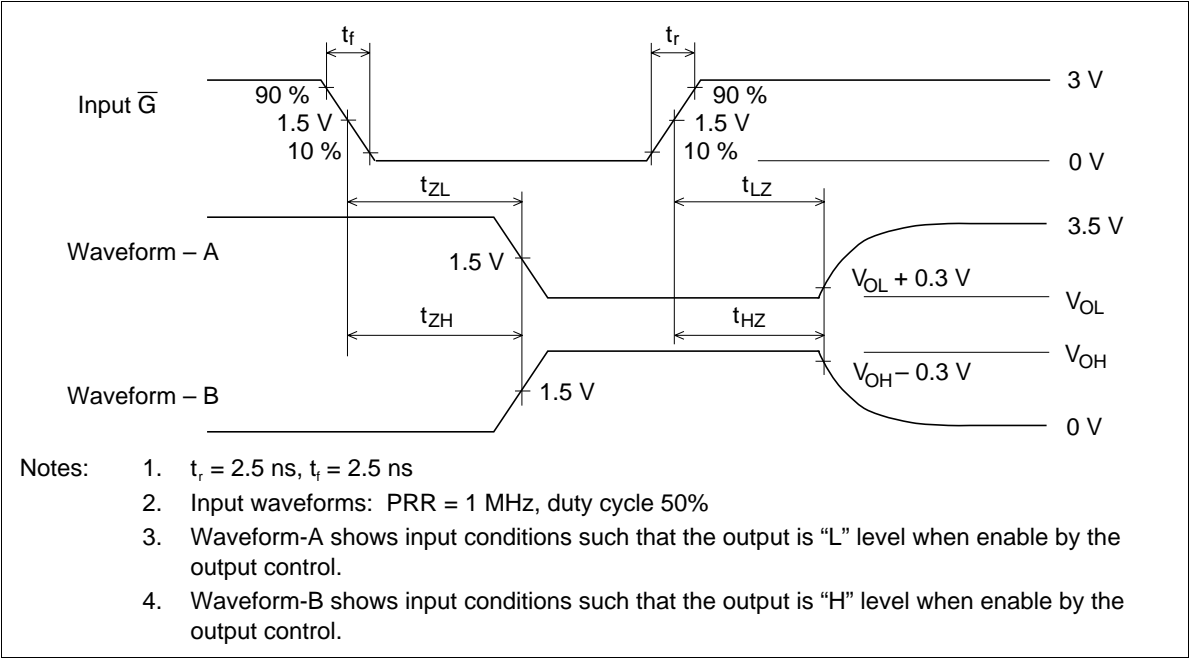
Test circuit



Waveforms-1



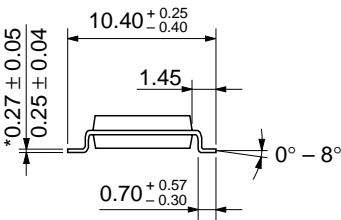
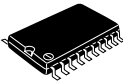
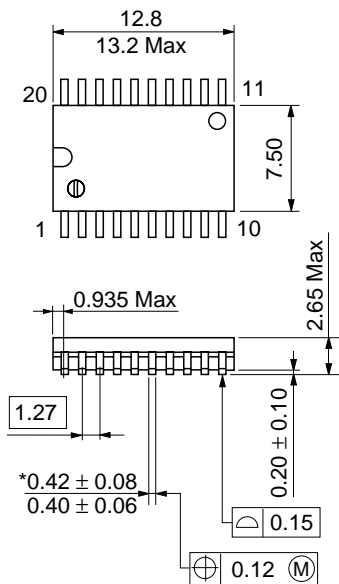
Waveforms-2







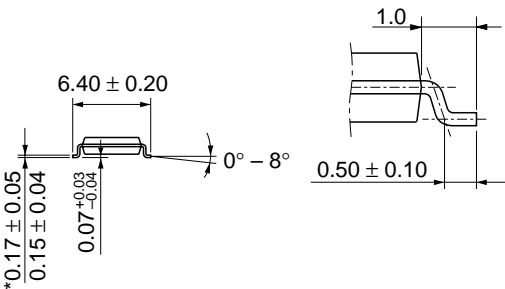
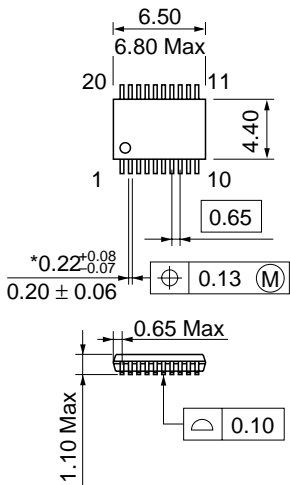
Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-20DB
JEDEC	Conforms
EIAJ	—
Mass (reference value)	0.52 g

Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	TTP-20DA
JEDEC	—
EIAJ	—
Mass (reference value)	0.07 g

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